As an inventor named below or on any attached continuation page, I hereby declare that:

My residence, post office address and citizenship are as stated next to my name.

I believe that I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled SLURRY FOR USE WITH FIXED-ABRASIVE POLISHING PADS IN POLISHING SEMICONDUCTOR DEVICE CONDUCTIVE STRUCTURES THAT INCLUDE COPPER AND TUNGSTEN AND POLISHING METHODS, the specification of which (check one):

8	is attached hereto.						
	was filed on	as United Sta	tes application serial no				
	was filed on	as PCT interr	national application no.	and was amend	led under PCT Article 19 on	·	
T he	reby state that I have r	eviewed and under	stand the contents of the above	e-identified specificat	tion, including the claims, as amend	ied by any amen	ndment
	d to above.			•		,,	
					wn to me to be material to the pater	ntability of the s	ubject
matter	claimed in this applicat	tion, as "materialit	y" is defined in Title 37, Code	of Federal Regulation	ons § 1.56.		
T he	rehy claim foreign pri	ority benefits unde	Title 35 United States Code	8 110(a)-(d) or 8 36	55(b) of any foreign application(s) f	or natent or inv	entor's
		•			than the United States of America	•	
			,, ,, ,	•	y foreign application for patent or in		
					erica having a filing date before tha		
which p	priority is claimed.		•				
	into more attendance						
Prior foreign/PCT application(s):					Priority Claimed		
						Friority Claim	ileu
	(number)		(coun	try)	(day/month/year filed)	Yes	No
	(h)				(day/month/year filed)	V	
	(number)		(count	ту)	(day/month/year filed)	Yes	No
T ba	and a plain the bonefit	under Title 25 I in	ited States Code R 120 of any	United States applie	ation(s) or § 365(c) of PCT interna	tional annliantia	-(-)
	•			• •		• • •	
					sofar as the subject matter of each		
pplicat	ion is not disclosed in	any such prior app	lication in the manner provided	d by the first paragra	ph of Title 35, United States Code,	§ 112, I acknow	wledge the
luty to	disclose to the U.S. Pa	tent and Trademar	k Office all information knows	n to me to be materia	al to patentability as defined in Title	37. Code of Fe	ederal
					national or PCT international filing		
СЕциа	ioib g 1.50 which occu	inc available between	son are ming date or such prior	r approvation and are	indomi or i or intermitedia indi	s dute or ans app	prication.
	(application serial)		(filing date)		(status - pending, patented or	abandanad)	
	(application serial i	110.)	(innig date)		(status - perionig, paterited of	abandoned)	
	(application serial t	no.)	(filing date)		(status - pending, patented or	abandoned)	
	(approduction out and		((outing personal of	20411001100)	
I he	reby claim the benefit t	under Title 35, Un	ited States Code, § 119(e) of a	ny United States prov	visional application(s) listed below:		
	(provisional applica	ation no.)	(filing date)				
	• • • • • • • • • • • • • • • • • • • •	·					
I her	eby appoint the follow	ing Registered Prac	ctitioners to prosecute this appl	lication and to transa	ct all business in the Patent and Tra	demark Office	connected
nerewit	h:						
Dovi	d V Track Dea No	22 012	William S Britt Deg No 2	n 060	Laurence B. Bond, Reg. No. 30.	540	
		James R. Duzan, Reg. No. 2				•	
	r R. Cataxinos, Reg. M		Kent S. Burningham, Reg. N		Allen C. Turner, Reg. No. 33,04 Stephen R. Christian, Reg. No. 3		
	G. Power, Reg. No.		Kenneth B. Ludwig, Reg. No.	0. 30,433 0. 42 814	Paul C. Oestreich, Reg. No. 44,9		
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	iel E. Webb, Reg. No.		David L. Stott, Reg. No. 43,		Kerry D. Tweet, Reg. No. 45,95		
	ley B. Jensen, Reg. No.		Michael L. Lynch, Reg. No.		Charles B. Brantley II, Reg. No.		
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ddress	all correspondence to:		G. Power, telephone no. (801)	532-1922.			
			K BRITT				
			OX 2550				
		San La	ike City, Utah 84110				
I her	hy declare that all stat	ements made herei	n of my own knowledge are tr	ue and that all statem	nents made on information and beli-	ef are believed t	n he mue.

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

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2832 E. Red Fix Court

DECLARATION FOR PATENT APPLICATIO (continuation page)

Invention title: SLURRY FOR USE WITH FIXED-ABRASIVE POLISHING PADS IN POLISHING SEMICONDUCTOR DEVICE CONDUCTIVE STRUCTURES THAT INCLUDE COPPER AND TUNGSTEN AND POLISHING METHODS

Inventor name(s) appearing on first declaration page: Dinesh Chopra

Additional original, first and joint inventor(s):

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